

## N-channel Enhancement Mode Power MOSFET

### Features

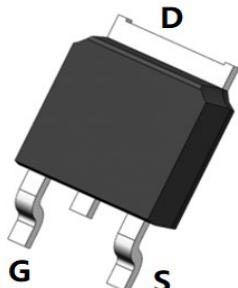
- $V_{DS} = 100V$ ,  $I_D = 40 A$
- $R_{DS(ON)} < 17m\Omega @ V_{GS} = 10V$
- $R_{DS(ON)} < 22 m\Omega @ V_{GS} = 4.5V$

### General Features

- Advanced Trench Technology
- Provide Excellent  $R_{DS(ON)}$  and Low Gate Charge
- Lead Free and Green Available

100% UIS TESTED!

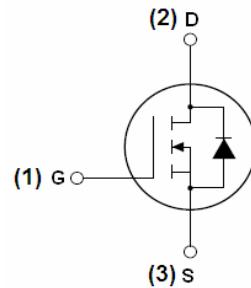
100%  $\Delta V_{ds}$  TESTED!



TO-252-2L Top View



Pin Assignment



Schematic Diagram

### Absolute Maximum Ratings ( $T_C=25^\circ C$ unless otherwise noted)

Parameter	Symbol	Limit	Unit
Drain-Source Voltage	$V_{DS}$	100	V
Gate-Source Voltage	$V_{GS}$	$\pm 20$	V
Drain Current-Continuous	$I_D$	40	A
Drain Current-Continuous( $T_C=100^\circ C$ )	$I_D(100^\circ C)$	28	A
Pulsed Drain Current	$I_{DM}$	160	A
Maximum Power Dissipation	$P_D$	140	W
Derating factor	-	0.94	W/ $^\circ C$
Single pulse avalanche energy <sup>(Note 5)</sup>	$E_{AS}$	520	mJ
Operating Junction and Storage Temperature Range	$T_J, T_{STG}$	-55 To 175	$^\circ C$

### Thermal Characteristic

Thermal Resistance,Junction-to-Case <sup>(Note 2)</sup>	$R_{\theta JC}$	1.07	$^\circ C/W$
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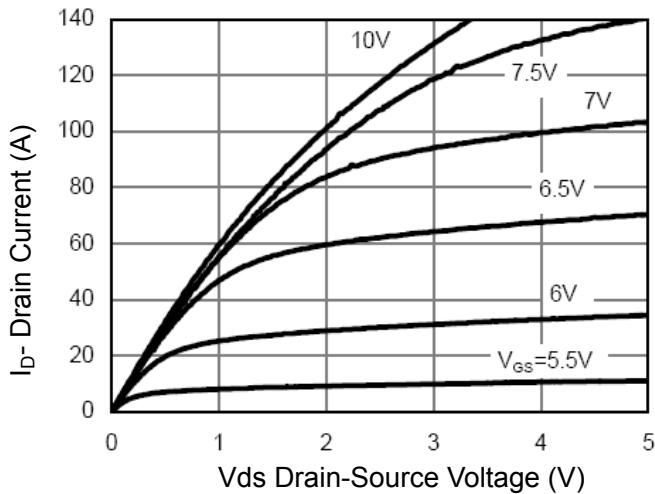
**Electrical Characteristics ( $T_C=25^\circ\text{C}$  unless otherwise noted)**

Parameter	Symbol	Condition	Min	Typ	Max	Unit
<b>Off Characteristics</b>						
Drain-Source Breakdown Voltage	$\text{BV}_{\text{DSS}}$	$\text{V}_{\text{GS}}=0\text{V}, \text{I}_D=250\mu\text{A}$	100	110	-	V
Zero Gate Voltage Drain Current	$\text{I}_{\text{DSS}}$	$\text{V}_{\text{DS}}=100\text{V}, \text{V}_{\text{GS}}=0\text{V}$	-	-	1	$\mu\text{A}$
Gate-Body Leakage Current	$\text{I}_{\text{GSS}}$	$\text{V}_{\text{GS}}=\pm20\text{V}, \text{V}_{\text{DS}}=0\text{V}$	-	-	$\pm100$	nA
<b>On Characteristics</b> <sup>(Note 3)</sup>						
Gate Threshold Voltage	$\text{V}_{\text{GS(th)}}$	$\text{V}_{\text{DS}}=\text{V}_{\text{GS}}, \text{I}_D=250\mu\text{A}$	2	4	-	V
Drain-Source On-State Resistance	$\text{R}_{\text{DS(ON)}}$	$\text{V}_{\text{GS}}=10\text{V}, \text{I}_D=28\text{A}$	-	17	-	$\text{m}\Omega$
Forward Transconductance	$\text{g}_{\text{FS}}$	$\text{V}_{\text{DS}}=25\text{V}, \text{I}_D=28\text{A}$	32	-	-	S
<b>Dynamic Characteristics</b> <sup>(Note 4)</sup>						
Input Capacitance	$\text{C}_{\text{iss}}$	$\text{V}_{\text{DS}}=30\text{V}, \text{V}_{\text{GS}}=0\text{V}, \text{F}=1.0\text{MHz}$	-	3400	-	PF
Output Capacitance	$\text{C}_{\text{oss}}$		-	290	-	PF
Reverse Transfer Capacitance	$\text{C}_{\text{rss}}$		-	221	-	PF
<b>Switching Characteristics</b> <sup>(Note 4)</sup>						
Turn-on Delay Time	$t_{\text{d(on)}}$	$\text{VDD}=30\text{V}, \text{ID}=2\text{A}, \text{RL}=15\Omega, \text{RG}=2.5\Omega, \text{VGS}=10\text{V}$	-	15	-	nS
Turn-on Rise Time	$t_r$		-	11	-	nS
Turn-Off Delay Time	$t_{\text{d(off)}}$		-	52	-	nS
Turn-Off Fall Time	$t_f$		-	13	-	nS
Total Gate Charge	$\text{Q}_g$	$\text{ID}=30\text{A}, \text{VDD}=30\text{V}, \text{VGS}=10\text{V}$	-	94	-	nC
Gate-Source Charge	$\text{Q}_{\text{gs}}$		-	16	-	nC
Gate-Drain Charge	$\text{Q}_{\text{gd}}$		-	24	-	nC
<b>Drain-Source Diode Characteristics</b>						
Diode Forward Voltage <sup>(Note 3)</sup>	$\text{V}_{\text{SD}}$	$\text{V}_{\text{GS}}=0\text{V}, \text{I}_s=28\text{A}$	-	0.85	1.2	V
Diode Forward Current <sup>(Note 2)</sup>	$\text{I}_s$		-	-	40	A
Reverse Recovery Time	$t_{\text{rr}}$	$\text{TJ} = 25^\circ\text{C}, \text{IF} = 28\text{A}$ $\text{di/dt} = 100\text{A}/\mu\text{s}$ <sup>(Note 3)</sup>	-	33	-	nS
Reverse Recovery Charge	$\text{Q}_{\text{rr}}$		-	54	-	nC
Forward Turn-On Time	$t_{\text{on}}$	Intrinsic turn-on time is negligible (turn-on is dominated by LS+LD)				

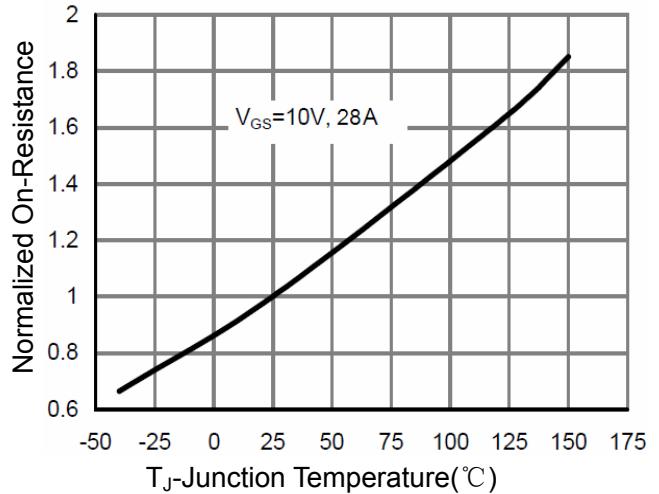
**Notes:**

1. Repetitive Rating: Pulse width limited by maximum junction temperature.
2. Surface Mounted on FR4 Board,  $t \leq 10$  sec.
3. Pulse Test: Pulse Width  $\leq 300\mu\text{s}$ , Duty Cycle  $\leq 2\%$ .
4. Guaranteed by design, not subject to production
5. EAS condition:  $\text{Tj}=25^\circ\text{C}, \text{V}_{\text{DD}}=50\text{V}, \text{V}_{\text{G}}=10\text{V}, \text{L}=0.5\text{mH}, \text{Rg}=25\Omega$

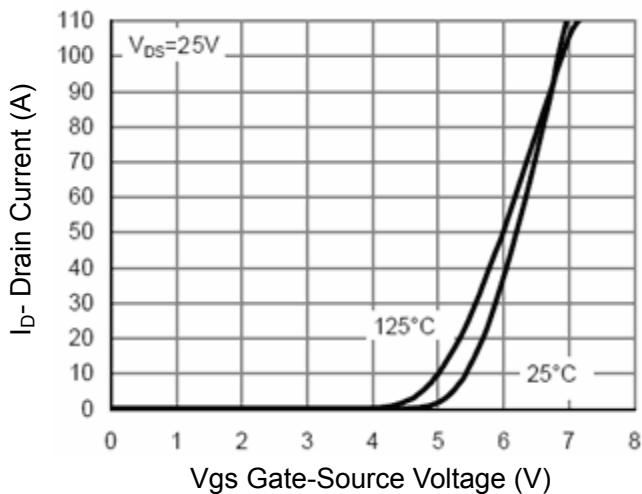
## Typical Electrical and Thermal Characteristics (Curves)



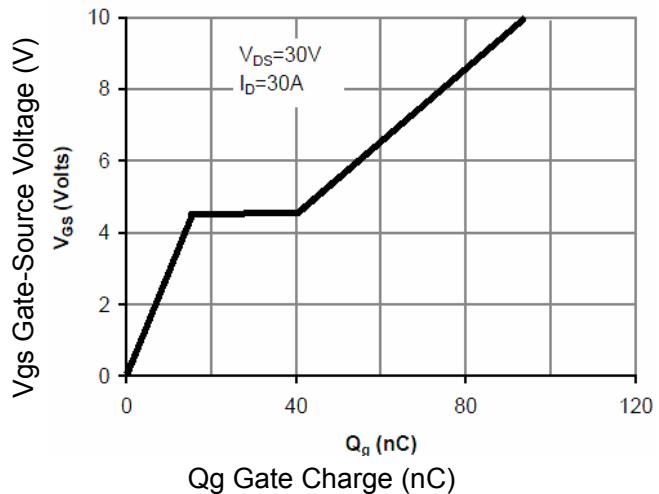
**Figure 1 Output Characteristics**



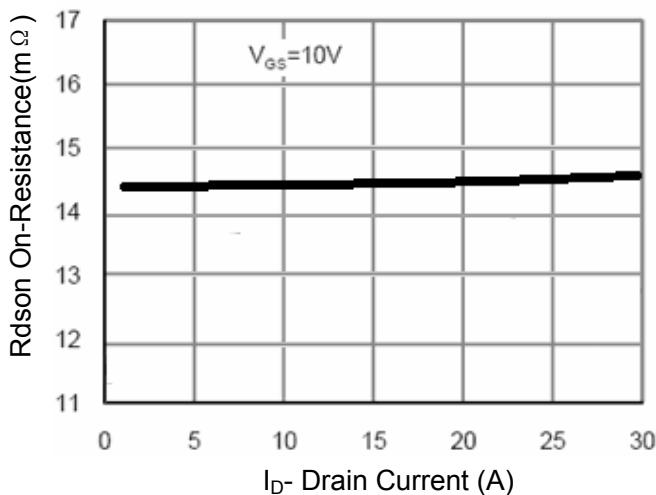
**Figure 4 Rdson-JunctionTemperature**



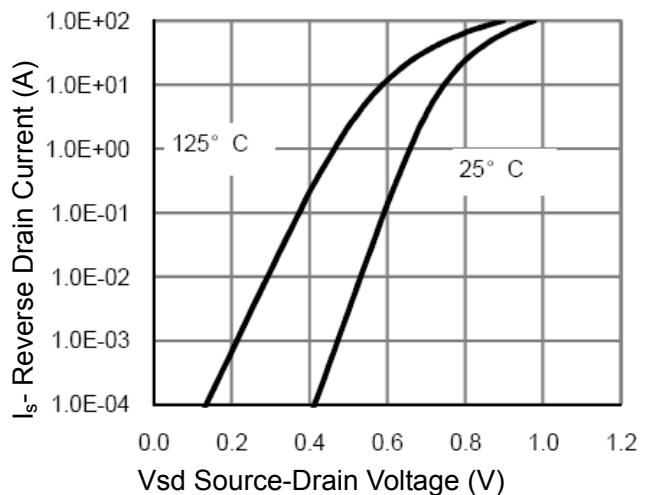
**Figure 2 Transfer Characteristics**



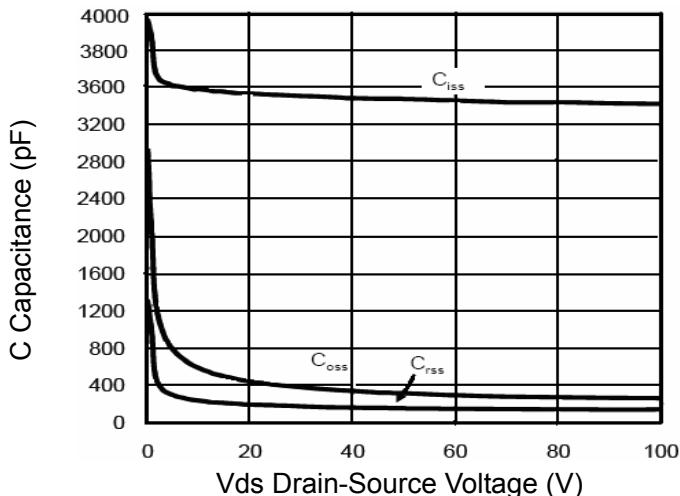
**Figure 5 Gate Charge**



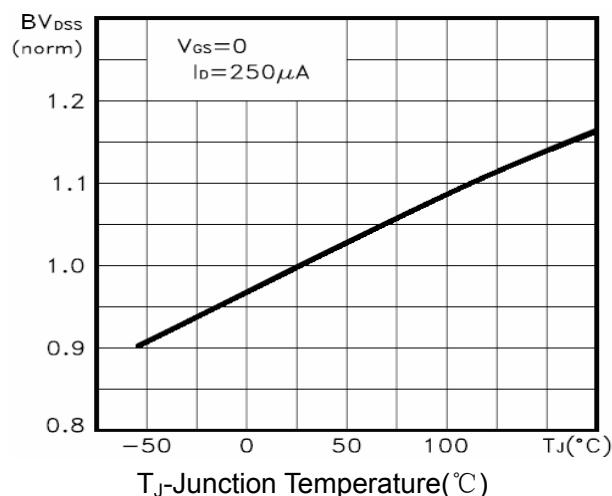
**Figure 3 Rdson- Drain Current**



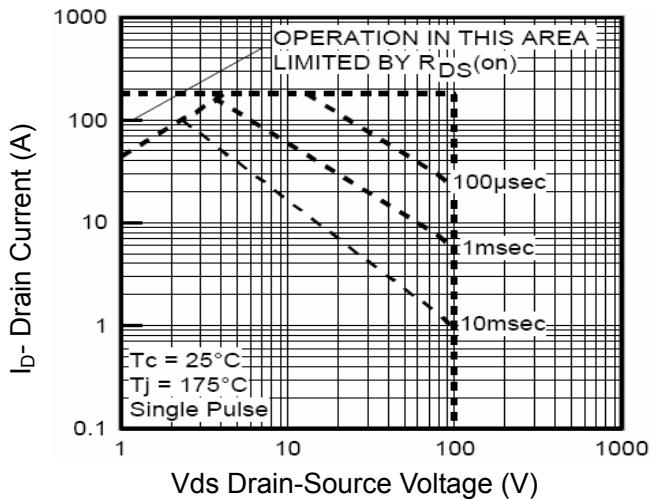
**Figure 6 Source- Drain Diode Forward**



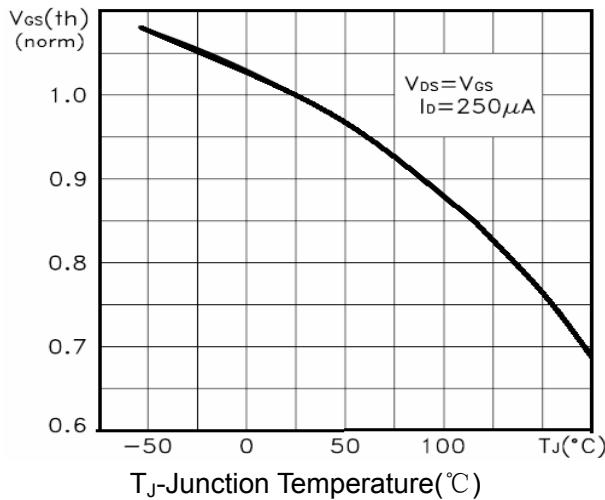
**Figure 7 Capacitance vs Vds**



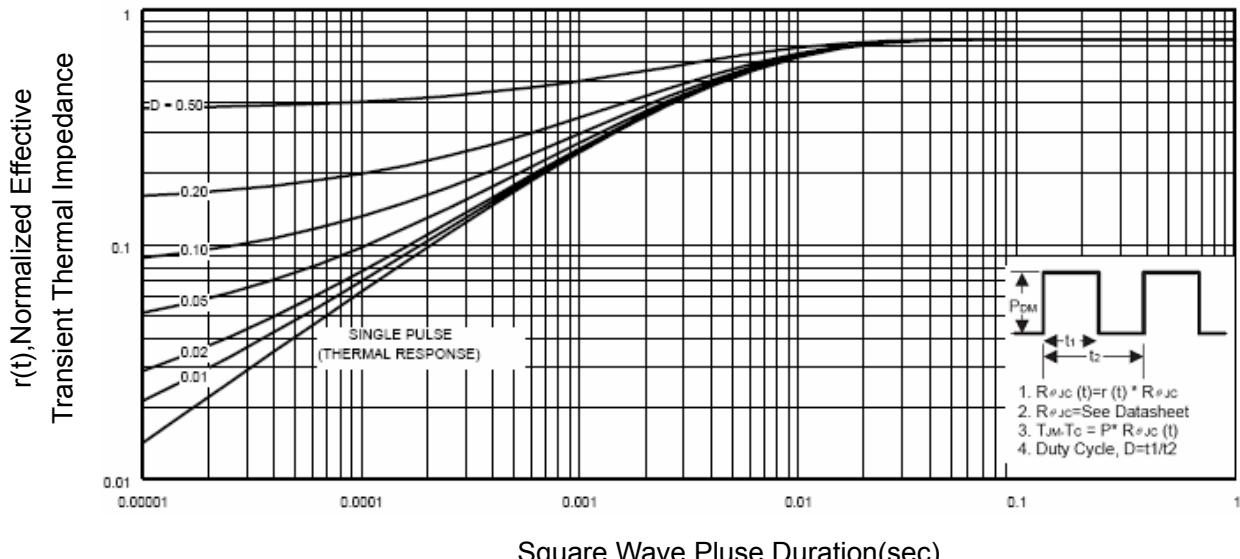
**Figure 9  $BV_{DSS}$  vs Junction Temperature**



**Figure 8 Safe Operation Area**



**Figure 10  $V_{GS(th)}$  vs Junction Temperature**



**Figure 11 Normalized Maximum Transient Thermal Impedance**